



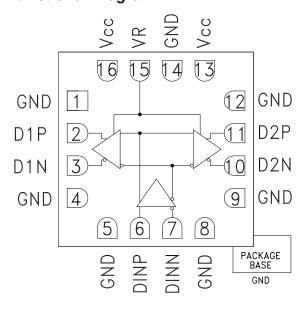
### 14 GBPS, FAST RISE TIME 1:2 FANOUT BUFFER w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

### Typical Applications

The HMC744LC3 is ideal for:

- RF ATE Applications
- Broadband Test & Measurement
- Serial Data Transmission up to 14 Gbps
- Clock Buffering up to 14 GHz

### **Functional Diagram**



#### **Features**

Inputs Terminated Internally to 50 Ohms
Differential & Single-Ended Operation

Propagation Delay: 120 ps

Fast Rise and Fall Times: 22 / 20 ps

Programmable Differential

Output Voltage Swing: 600 - 1100 mV Low Power Consumption: 287 mW typ.

Single Supply: +3.3 V

16 Lead Ceramic 3x3 mm SMT Package: 9 mm²

### General Description

The HMC744LC3 is a 1:2 Fanout Buffer designed to support data transmission rates up to 14 Gbps, and clock frequencies as high as 14 GHz.

All differential inputs to the HMC744LC3 are CML and terminated on-chip with 50 Ohms to the positive supply, Vcc, and may be AC or DC coupled. The differential CML outputs are source terminated to 50 Ohms and may also be AC or DC coupled. Outputs can be connected directly to a 50 Ohm Vcc-terminated system, while DC blocking capacitors may be used if the terminating system is 50 Ohms to ground. The HMC744LC3 also features an output level control pin, VR, which allows for loss compensation or signal-level optimization. the HMC744LC3 operates from a single 3.3 V supply and is available in ROHS-compliant 3x3 mm SMT package.

### Electrical Specifications, T<sub>A</sub> = +25 °C, Vcc = 3.3 V, VR = 3.3 V

| Parameter                | Conditions                 | Min.      | Тур.    | Max       | Units |
|--------------------------|----------------------------|-----------|---------|-----------|-------|
| Power Supply Voltage     |                            | 3.0       | 3.3     | 3.6       | V     |
| Power Supply Current     |                            |           | 87      |           | mA    |
| Maximum Data Rate        |                            |           | 14      |           | Gbps  |
| Maximum Clock Rate       |                            |           | 14      |           | GHz   |
| Input Voltage Range      |                            | Vcc - 1.5 |         | Vcc + 0.5 | V     |
| Input Differential Range |                            | 0.1       |         | 2         | Vp-p  |
| Input Return Loss        | Frequency <14 GHz          |           | 10      |           | dB    |
| Output Amplitude         | Single-Ended, peak-to-peak |           | 550     |           | mVp-p |
|                          | Differential, peak-to-peak |           | 1100    |           | mVp-p |
| Output High Voltage      |                            |           | 3.29    |           | V     |
| Output Low Voltage       |                            |           | 2.74    |           | V     |
| Output Rise / Fall Time  | Single-Ended, 20% - 80%    |           | 22 / 20 |           | ps    |





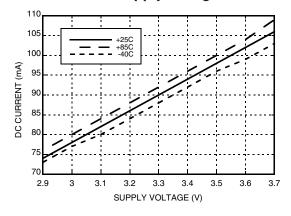
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### **Electrical Specifications** (continued)

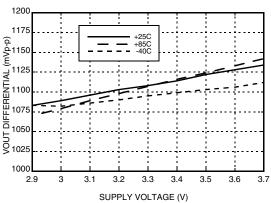
| Parameter                             | Conditions  | Min. | Тур. | Max | Units  |
|---------------------------------------|---|------|------|-----|--------|
| Output Return Loss                    | Frequency <13 GHz                                   |      | 10   |     | dB     |
| Small Signal Gain                     |   |      | 27   |     | dB     |
| Random Jitter J <sub>R</sub>          | rms   |      |      | 0.2 | ps rms |
| Deterministic Jitter, J <sub>D</sub>  | δ - δ, 2 <sup>15</sup> -1 PRBS input <sup>[1]</sup> |      | 2    | 6   | ps     |
| Propagation Delay, td                 |   |      | 120  |     | ps     |
| D1 to D2 Data Skew, t <sub>SKEW</sub> |   |      | <2   |     | ps     |
| VR Pin Current                        | VR = 3.3 V  |      | 2    |     | mA     |
| VR Pin Current                        | VR = 3.7 V  |      |      | 3.5 | mA     |

<sup>[1]</sup> Deterministic jitter measured at 13 GHz with a 300 mVp-p, 2<sup>15</sup>-1 PRBS input sequence.

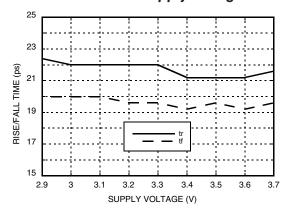
### DC Current vs. Supply Voltage [1][2]



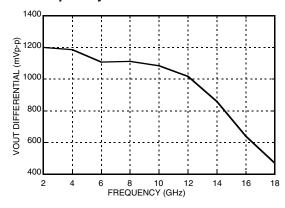
### Output Differential Voltage vs. Supply Voltage [1][2]



### Rise / Fall Time vs. Supply Voltage [1][2]



### Output Differential Voltage vs. Frequency [1][3]



[1] VR = 3.3 V

[2] Frequency = 13 GHz

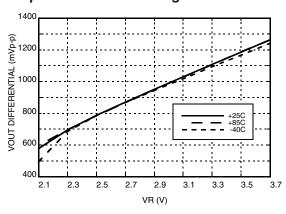
[3] Vcc = 3.3 V



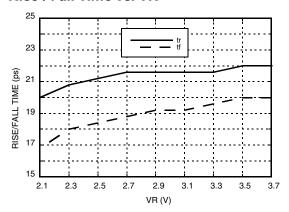


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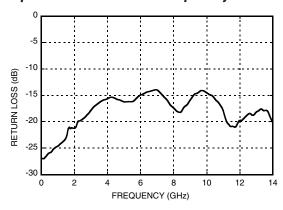
### Output Differential Voltage vs. VR [1][2]



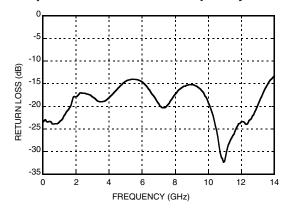
### Rise / Fall Time vs. VR [1][2]



### Input Return Loss vs. Frequency



### **Output Return Loss vs. Frequency**

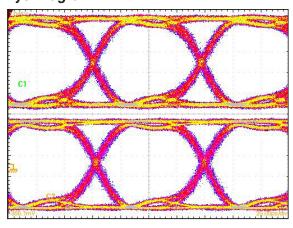






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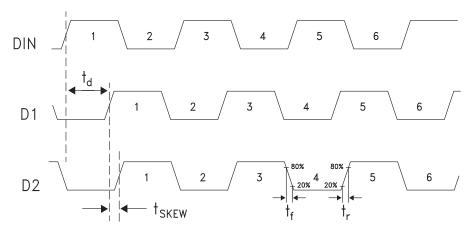
### Eye Diagram



#### [1] Test Conditions:

Pattern generated with an Agilent N4903A Serial BERT.
Eye Diagram presented on a Tektronix CSA 8000.
Device input = 13 Gbps PN code. Both output channels shown.
Device is AC coupled to scope

### **Timing Diagram**



#### **Truth Table**

| Input   | Outputs   |    |  |
|---|---|----|--|
| DIN   | D1  | D2 |  |
| L   | L   | L  |  |
| Н   | Н   | Н  |  |
| Notes:<br>DIN = DINP - DINN<br>D1 = D1P - D1N<br>D2 = D2P - D2N | H - Positive differential voltage L - Negative differential voltage |    |  |





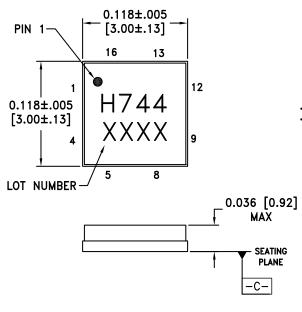
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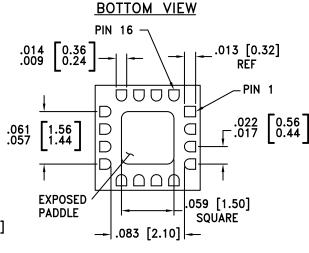
### **Absolute Maximum Ratings**

| Power Supply Voltage (Vcc)  | Vcc -0.5 V to +3.75 V    |  |
|---|--------------------------|--|
| Input Signals   | Vcc -2.0 V to Vcc +0.5 V |  |
| Output Signals  | Vcc -1.5 V to Vcc +0.5 V |  |
| Continuous Pdiss (T = 85 °C)<br>(derate 17 mW/°C above 85 °C)                   | 0.68 W                   |  |
| Thermal Resistance (R <sub>th j-p</sub> ) Worst case junction to package paddle | 59 °C/W                  |  |
| Maximum Junction Temperature  | 125 °C                   |  |
| Storage Temperature   | -65 °C to +150 °C        |  |
| Operating Temperature   | -40 °C to +85 °C         |  |
| ESD Sensitivity (HBM)   | Class 1C                 |  |



### **Outline Drawing**





#### NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING:
- 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM -C-
- 6. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
- 7. PADDLE MUST BE SOLDERED TO GND.

### Package Information

| Part Number | Package Body Material | Lead Finish      | MSL Rating | Package Marking [2] |
|-------------|-----------------------|------------------|------------|---------------------|
| HMC744LC3   | Alumina, White        | Gold over Nickel | MSL3 [1]   | H744<br>XXXX        |

<sup>[1]</sup> Max peak reflow temperature of 260 °C

<sup>[2] 4-</sup>Digit lot number XXXX





# 14 GBPS, FAST RISE TIME 1:2 FANOUT BUFFER w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

### **Pin Descriptions**

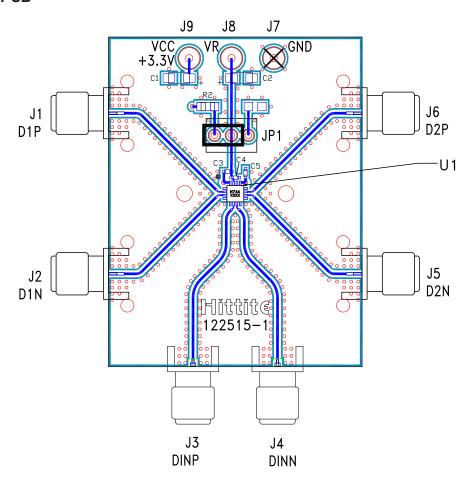
| Pin Number          | Function             | Description   | Interface Schematic    |
|---------------------|----------------------|---|------------------------|
| 1, 4, 5, 8, 9, 12   | GND                  | Signal Grounds  | → GND<br>=             |
| 2, 3<br>10, 11      | D1P, D1N<br>D2N, D2P | Differential Data Outputs: Current Mode Logic (CML) referenced to positive supply.                                    | DxP O DxN              |
| 6, 7                | DINP, DINN           | Differential Data Inputs: Current Mode Logic (CML) referenced to positive supply.                                     | GND O GND  DINP O DINN |
| 13, 16              | Vcc                  | Positive Supply   |                        |
| 14,<br>Package Base | GND                  | Supply Ground   | GND<br>=               |
| 15                  | VR                   | Output level control. Output level may be adjusted by applying a voltage to VR per "Output Differential vs. VR" plot. | VR 0                   |





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#### **Evaluation PCB**



### List of Materials for Evaluation PCB 122517 [1]

| Item    | Description                                  |
|---------|--|
| J1 - J6 | PCB Mount SMA RF Connectors                  |
| J7 - J9 | DC Pin                                       |
| JP1     | Shorting Jumper                              |
| C1, C2  | 4.7 μF Capacitor, Tantalum                   |
| C3 - C5 | 100 pF Capacitor, 0402 Pkg.                  |
| R2      | 10 Ohm Resistor, 0603 Pkg.                   |
| U1      | HMC744LC3<br>High Speed Logic, Fanout Buffer |
| PCB [2] | 122515 Evaluation Board                      |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR or rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed packaged base should be connected to GND. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. Install jumper on JP1 to short VR to Vcc for normal operation.